

Product Change Notice

Issue Date: June 8, 2018**Change Type:**

Removing portion of heatsink fin located behind RAID upgrade key.

Parts Affected:

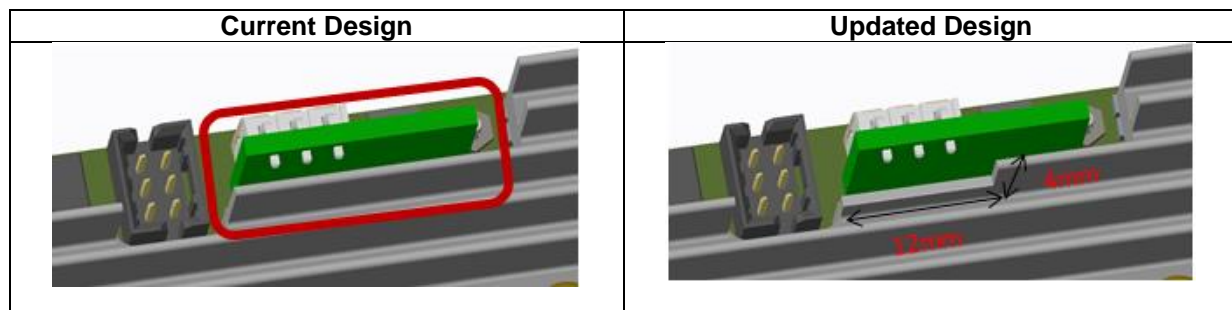
The following part numbers are impacted by this change:

- 03-50011-30
- 05-50011-00
- 03-50011-31
- 03-50011-54
- 03-50011-55
- 03-50011-56
- 05-50011-05
- 05-50011-06
- 03-50011-61
- 03-50049-03
- 03-50011-53
- 03-50011-52
- 03-50011-33
- 03-50011-65
- 03-50011-66
- 03-50011-67

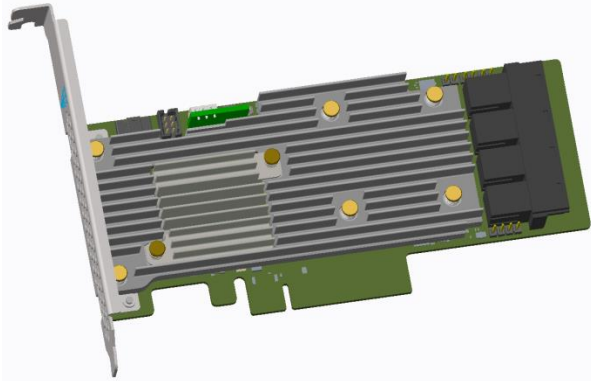
Description of Change:

Current 9460-16i and 9460-8i heatsink design increases the risk of shorting the RAID upgrade key if the board is mishandled. This could occur if the handler puts too much stress on the RAID upgrade key causing it to bend into the heatsink. This may cause the component mounting pins on the RAID upgrade key to touch the heatsink resulting in a short.

To lessen this risk, a portion of the heatsink fin behind the RAID upgrade key is being removed.



For reference, this picture shows where the key is located on the board:



Effect of Change:

There is no change to form, fit or function. This is a small portion of the overall heatsink located in an area that will have no impact on the thermal solution. Airflow and temperature requirements do not change. There will be no changes to part numbers or revisions.

Effective Date of Change:

Product shipments using this change will begin on or around 90 days after date on this PCN. The initiation of the change may be spread over approximately 6 months depending on customer volumes and inventory levels.

The changes to these Broadcom parts have been reviewed and approved by Broadcom engineers and managers per Broadcom procedure: Change Control and Customer Notification A-5962-6052-80.

Please contact your Broadcom Inc. field sales engineer or Contact Center (<http://www.broadcom.com/contact/>) for any questions or support requirements. Please return any response as soon as possible, but not to exceed 30 days.